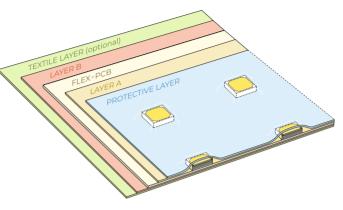
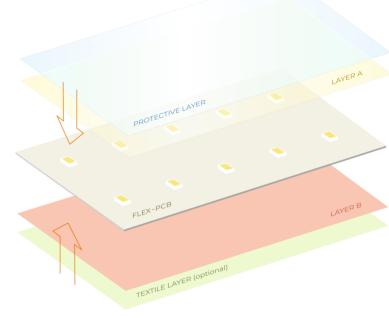
Innovative Lamination Process for Flexible Electronics and LED Technology









INNOVATIVE TECHNOLOGY

The Lamination Process

In the new production plant, both flat and linear electronic assemblies are laminated with several polymer materials. The material composition can be adapted depending on the intended use. The total layer thicknesses are 200 μm - 1000 μm . In the lamination process, several plastic layers are applied to the front and back of the flexible PCB material by applying heat (temperatures < 230°C) and high pressure. The components mounted on the flexible

components are encapsulated in this process, whereby air residues in the material composite are largely displaced. Since only very thin layers are used, the flexibility of the module is maintained and at the same time the mechanical resistance increases significantly. The high transparency and low colour shifts of the materials used makes the innovative technology a perfect complement for assemblies with LEDs or optical sensors.



HIGH PROTECTIVE EFFECT

Well Protected for Difficult Operating Conditions

The innovative lamination technology offers reliable protection against a wide range of environmental influences. Whether solar radiation, wind or water - the modules can withstand any weather and can thus be used in outdoor areas for flexible lighting solutions, for example. Furthermore, the lamination reliably protects flexible modules against various chemicals from the air, such as exhaust

fumes, or in direct contact with the surface with paint, cleaning agents or dust. Mechanical stresses, such as direct contact with the electronics by the user, can also be largely avoided. Despite the lamination, the flexibility of the assembly is maintained so that multi-dimensional installations remain possible.



Protected against humidity (IP67 possible)



Protected against gases, dust and other particles



Protected against various chemicals



Protected against physical stress and weather influences

LUMPROTECT® IN COMPARISON

How Can Lighting Applications Be Protected from Environmental Influences?



HOUSING



COATING/ PROTECTIVE LACQUER



POTTING



LUMPROTECT®

Besides LumProtect®, there are three common methods that are used to protect sensitive electronics. Depending on the application requirements of the respective electronics application, the common protection methods can achieve very good results, but also show strong weaknesses in certain criteria.

For example, in many applications it is important that flexible LED

modules remain very flexible even when protected, so that threedimensional installations can be implemented without restrictions. As only very thin layers are fused together during the LumProtect® lamination, the flexibility of the LED module is still maintained. At the same time, the mechanical resistance increases significantly.

Chemical composition. high e.g. acrylic or silicone Chemical composition, e.g. polyurethane **Flexibility** Compositions based on e.g. polyurethanes, silicones Compositions on the basis of e.g. epoxides low medium high **Protection** Potting

LUMPROTECT® IN COMPARISON

LumProtect® vs. Potting

We have also evaluated other properties of the common protection methods and compared them with the characteristics of LumProtect®.

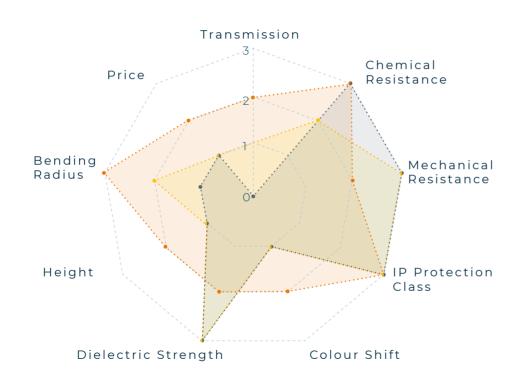
LumProtect®

Silicone Potting

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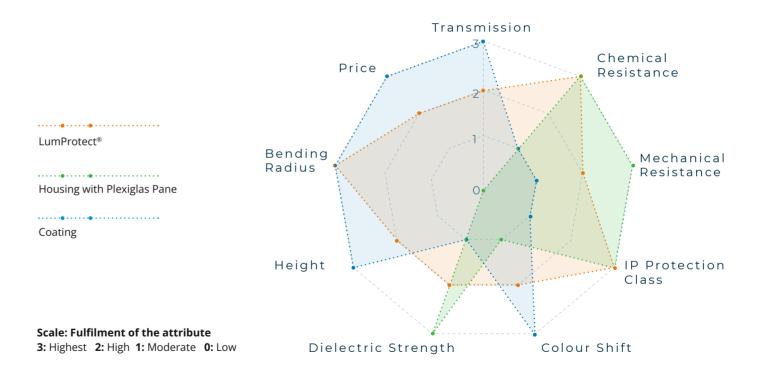
Epoxy Potting 2K-PUR

Scale: Fulfilment of the attribute
3: Highest 2: High 1: Moderate 0: Low



LUMPROTECT® IN COMPARISON

LumProtect® vs. Coating vs. Housing



PROTECTED LIGHTING

Perfectly Suitable

The high transparency of the materials used makes the innovative LumProtect® technology a perfect complement for assemblies with LEDs or optical sensors.

It brings unique features that cannot be achieved by other protection methods in applications with flexible LED strips and flexible area modules.



Maximum customisability with protected lighting



Highest flexibility
with protected lighting



Highest colour fidelity with protected lighting



Lowest overall height with protected lighting

Features

MECHANICAL PARAMETERS:

- Minimum bending radius
- Hardness: 70 Shore D (ISO 868)
- Max. ambient temperature
- Fire protection class V-0

OPTICAL PARAMETERS:

- No yellowing effects
- High material transparency
 (92 94 % typical)
- **Hardly any colour shifts** (< 200 K with warm white LED light)

ENVIRONMENTAL INFLUENCES:

- IP67 protection = standard
- Dry heat (DIN 60068-2-2)
- Temperature and humidity cycles (DIN 60068-2-38)
- Salt spray test (DIN EN 60068-2-11: 2000-02)

- **High dielectric strength** (> 80 kV / mm, 4-5 KV at 50 μm)
- Structured and smooth surfaces
- Customised designs, shapes and colours through the use of textile layers
- Different connection and sealing options with cables, plugs, eyelets
 & crimp contacts
- Applicable to the entire LUMITRONIX® standard portfolio with LED strips and customerspecific solutions on flexible substrates

TECHNOLOGY DEMONSTRATORS AVAILABLE

See for Yourself

To showcase the quality of the technology, we offer two laminated LED modules: a **surface module** and an **LED strip**. The technology is applicable to the entire standard product portfolio of LUMITRONIX® on flexible base materials and can also be used for customised flexible LED solutions within the scope of individual projects.









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